

UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR .	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/939,417	08/24/2001	Leonard Forbes	MICRON.154A / 00-0184	4204
20995	7590 11/01/2002			
KNOBBE MARTENS OLSON & BEAR LLP 2040 MAIN STREET FOURTEENTH FLOOR IRVINE, CA 92614			EXAMINER	
			LEWIS, MONICA	
IK VINE, CA	92014		ART UNIT	PAPER NUMBER

2822 DATE MAILED: 11/01/2002

Please find below and/or attached an Office communication concerning this application or proceeding.

PTO-90C (Rev. 07-01)

	Application No.	Applicant(s)	. 1
· · · · · · · · · · · · · · · · · · ·		FORBES, LEONAF	RD
	09/939,417	Art Unit	
Office Action Summary	Examiner	2822	
	Monica Lewis	vith the correspondence ad	dress
The MAILING DATE of this communication	appears on the cover enter		
Period for Reply A SHORTENED STATUTORY PERIOD FOR RE	PLY IS SET TO EXPIRE 31	MONTH(S) FROM	
THE MAILING DATE OF THE GOVERNMENT OF 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provisions of 37 CF Extensions of time may be available under the provision of 37 CF Extensions of time may be available under the provision of 37 CF Extensions of time may be available under the provision of 37 CF Extensions of time may be available under the provision of 37 CF Extensions of time may be available under the provision of 37 CF Extensions of time may be available under the provision of 37 CF Extensions of time may be available under the provision of 37 CF Extensions of time may be available under the provision of 37 CF Extensions of time may be available under the provision of 37 CF Extension of time may be available under the provision of 37 CF Ex	R 1.136(a). In no event, however, may the	nirty (30) days will be considered time	ly. communication.
 Extensions of time may be available under the providence after SIX (6) MONTHS from the mailing date of this communication after SIX (6) MONTHS from the mailing date of this communication. If the period for reply specified above is less than thirty (30) days, if NO period for reply is specified above, the maximum statutory period for reply within the set or extended period for reply will, by any reply received by the Office later than three months after the earned patent term adjustment. See 37 CFR 1.704(b). 	eriod will apply and will expire SIX (6) Mistatute, cause the application to become mailing date of this communication, ever	JN I IS IIOIN ABANDONED (35 U.S.C. § 133). ABANDONED (35 U.S.C. § 133). If timely filed, may reduce any	
	. 13 August 2002 .		
Status 1) Responsive to communication(s) filed or 2015 1 1 1 1 1 1 1 1 1	This action is non-final.		
1 0-1M This action is thinks.		matters, prosecution as to	the merits is
2a) ☐ This action is FINAL . 2b) ☐ Since this application is in condition for a closed in accordance with the practice L	inder Ex parte Quayle, 1935	C.D. 11, 453 O.G. 213.	
Disposition of Claims	cation.		
4)⊠ Claim(s) <u>1-22</u> is/are pënding in the appli 4a) Of the above claim(s) is/are w	ithdrawn from consideration.	•	
4a) Of the above claim(s) is/arc w			
5) Claim(s) is/are allowed.			
6)⊠ Claim(s) <u>1-22</u> is/are rejected.			
7) Claim(s) is/are objected to.	and/or election requiremen	t.	
8) Claim(s) are subject to restriction	1 and/or ciconom 1		
Application Papers	veminor		
9) The specification is objected to by the E 10) The drawing(s) filed on is/are: a)	Concepted or b) objected to	by the Examiner.	
10) The drawing(s) filed on is/are: a) Applicant may not request that any object	ion to the drawing(s) be held in	abeyance. See 37 CFR 1.85	6(a).
Applicant may not request that any object	d b	o) disapproved by the Exa	aminer.
11) The proposed drawing correction filed of			
If approved, corrected drawings are requ	w the Examiner.		
12) The oath or declaration is objected to b	y the Exercise		
Priority under 35 U.S.C. §§ 119 and 120	familian priority under 35 U	.S.C. § 119(a)-(d) or (f).	
13) Acknowledgment is made of a claim to	or foreign priority arrass		
* o\			
1. Certified copies of the priority of	locuments have been receive	ed in Application No	
1. ☐ Certified copies of the priority of 2. ☐ Certified copies of the priority of	locuments have been reserved	e been received in this Na	tional Stage
3. Copies of the certified copies of	of the priority documents have ational Bureau (PCT Rule 17	(.2(a)).	
* See the attached detailed Office action	and amostic priority under 35	U.S.C. § 119(e) (to a prov	isional application).
* See the attached detailed Office action 14) Acknowledgment is made of a claim for a cla	oquage provisional applicatio	n has been received.	1
a) The translation of the foreign lar 15) Acknowledgment is made of a claim to	for domestic priority under 35	5 U.S.C. §§ 120 and/or 12	1.
15) Acknowledgment is made of a claim	. —	•	eaner No(s).
Attachment(s)	[7]	Interview Summary (PTO-413) F Notice of Informal Patent Applica	ation (PTO-152)
 Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (Information Disclosure Statement(s) (PTO-1449) 	F10-3-01 = -1	Other:	Part of Paper No. 7
3) [_] sillottica	Office Action Summary		Fair Oil Mat. 110

Art Unit: 2822

DETAILED ACTION

This office action is in response to the amendment filed August 24, 2002. 1.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the 2. basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- Claims 1-22 are rejected under 35 U.S.C. 102(b) as being anticipated by Forbes et al. 3. (U.S. Patent No. 5,936,274).

In regards to claims 1 and 20, Forbes et al. discloses (Col. 1; line 50 to 55) a memory cell includes a pillar 300 of semiconductor material that extends outwardly from a working surface of a substrate. (Col. 1; line 50 to 55). The floating gate transistor includes a first conductivity type semiconductor pillar. (Col. 1; line 64 to 67). The floating gate transistor 105 and 200 includes a first conductivity type semiconductor pillar. The pillar has top and side surfaces and is formed upon the substrate. (Col. 2; line 1 to 5). A first source/drain region, of a second conductivity type, is formed proximal to an interface between the pillar and the substrate. A second source/drain region, of a second conductivity type, is formed in a portion of the pillar that is distal to the substrate and separate from the first source/drain region. (Col. 2; line 19 to 25). A second source/drain region, of a second conductivity type, is formed in a portion of the pillar that is distal to the substrate and separate from the first source/drain region. A gate dielectric 330 and 1000 is formed on at least a portion of the side surface of the pillar. (Col. 2; line 29 to 31).

Art Unit: 2822

An intergate dielectric 340 and 1300 is formed, interposed between each of the substantially adjacent floating and control gates (Col. 7; line 1 to 4). Cells 205 has two floating gate transistors 200, such as cell 205BB. In FIG. 4, each of the two floating gates 325 is adjacent to one of opposing sides of pillar 300, and separated therefrom by gate dielectric 330. (Col. 7; line 4 to 10) Each control gate 335 is separated from a corresponding floating gate 325 by an intergate dielectric 340. Each control gate 335 is integrally formed together with one of the gate.

Regarding claims 2, 4, 7, 8, 18,19, 21 and 22, (Col. 3; line 30 to 35) each control gate is associated with a floating gate so as to allow programming by selective storage and retrieval of data on the floating gates (Col. 8; line 15 to 20) if there are no electrons stored on the floating gate 325, the floating gate transistor 200 will conduct between its source region 310 and drain region 315. (Col. 8; line 21 to 25). If there are electrons stored on the floating gate 325, the floating gate transistor 200 will not conduct between its source region 310 and drain region 315. (Col. 7; line 28 to 30). Programming of one of the floating gate transistors 200 is by hot electron injection. (Col. 7; line 55 to 57) The floating gate transistor 200 may be programmed instead by Fowler-Nordheim tunneling of electrons (Col. 3; line 30 to 35). If a floating gate transistor is used to store a single bit of data, an area of only 2F.sup.2 is needed per bit of data.

Regarding claims 3 and 10, (Col. 10, line 45 to 60) a selective etch, which preferentially removes silicon dioxide but doesn't substantially remove polysilicon, is used to etch into portions of silicon dioxide insulator 605, but not the portions of polysilicon conductive layer 1005 in second troughs 700. (Col. 11; line 28 to 31) An isotropic chemical etch is used to fully undercut the semiconductor regions or pillar separating the first troughs 600, and a subsequent oxidation step is used to fill in the evacuated regions formed by the undercutting.

Art Unit: 2822

Regarding claims 5, 6 and 11, (Col. 5; line 34 to 40) In one embodiment, substrate 305 is a bulk semiconductor, such as P- silicon. In another embodiment, a semiconductor-on-insulator (SOI) substrate 305 includes an insulating layer, such as silicon dioxide Si02. (Col. 5; line 1 to 5) A number of vertical floating gate (extend outwardly) field-effect transistors (FETS) formed on the sides of a semiconductor pillar on a substrate.

Regarding claims 9 and 13, (ABSTRACT) First source/drain terminals are row addressable, which is arranged in rows. Second source/drain terminals are column addressable, which is arranged in columns. (Col. 2; line 5 to 10) a gate dielectric 330 is formed on at least a portion of the side surface of the pillar. A plurality of floating gates are formed on opposing sides of the pillar 300. Each floating gate 325 is substantially adjacent to a portion of the side surface of the pillar and separated therefrom by the gate dielectric. A plurality of control gates are formed, each of which is substantially adjacent to one of the floating gates and insulated therefrom. An intergate dielectric 340 is formed, interposed between each of the substantially adjacent floating and control gates.

Regarding claims 12 and 14, (Col. 6; line 15 to 25) each floating gate 325 has a corresponding substantially adjacent control gate 335, from which it is separated by an intergate dielectric 340. Except at the periphery of array 105, each control gate 335 is interposed between two approximately adjacent pillars 300 and shared by two floating gate transistors 200, each of these floating gate transistors 200 having portions in one of the two approximately adjacent pillars 300.

Art Unit: 2822

Regarding claims 15, 16 and 17, (Col. 6; line 33 to 36) (FIG. 1) each of the gate lines XG1, XG2, XGN interconnects along the column ones of the control gates 335. For example, gate line XG2 electrically interconnects control gates 335 (Col. 6; line 60 to 65) FIG. 3B illustrates a row of cells 205, 205AA, 205BA, 205NA, having source regions 310 electrically interconnected by one of first source/drain interconnection lines YS1, YS2, YSN, e.g. first source/drain interconnection line YS1, formed in substrate 305. (ABSTRACT) Second source/drain terminals are electrically connected or column addressable by data lines. (Col. 5; line 55 to 60) First source/drain region interconnection line YS1 electrically interconnects the source region 310 of each pillar 300 of cells 205AA, 205BA, 205NA. In one embodiment, the first source/drain interconnection lines YS1, YS2, YSN.

Response to Arguments

4. Applicant's arguments filed August 13, 2002 have been fully considered but they are not persuasive. Applicant argues that "Forbes does not teach a floating gate transistor wherein a control gate overlays a floating gate." However, Forbes does teach a control gate (335) that overlays a floating gate (325) (See Figure 4). Therefore, Applicant's arguments are not persuasive.

Conclusion

5. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE

MONTHS from the mailing date of this action. In the event a first reply is filed within TWO

MONTHS of the mailing date of this final action and the advisory action is not mailed until after

Art Unit: 2822

the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

6. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Monica Lewis whose telephone number is 703-305-3743. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Amir Zarabian can be reached on 703-308-4905. The fax phone number for the organization where this application or proceeding is assigned is 703-308-7722 for regular and after final communications. Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

ML October 25, 2002

AMIR ZARABIAN

AMIR ZARABIAN

SUPERVISORY PATENT EXAMINER

TECHNOLOGY CENTER 2800